

### STH360N4F6-2

# N-channel 40 V, 180 A STripFET™ VI DeepGATE™ Power MOSFET in H²PAK-2 package

Datasheet - preliminary data

#### **Features**

Order code	V <sub>DSS</sub>	R <sub>DS(on)</sub> max	I <sub>D</sub>
STH360N4F6-2	40 V	$<$ 1.25 m $\Omega$	180 A <sup>(1)</sup>

- 1. Current limited by package
- Low gate charge
- Very low on-resistance
- High avalanche ruggedness

#### **Applications**

■ Switching applications

### **Description**

This device is an N-channel Power MOSFET developed using the  $6^{th}$  generation of STripFET<sup>TM</sup> DeepGATE<sup>TM</sup> technology, with a new gate structure. The resulting Power MOSFET exhibits the lowest R<sub>DS(on)</sub> in all packages.

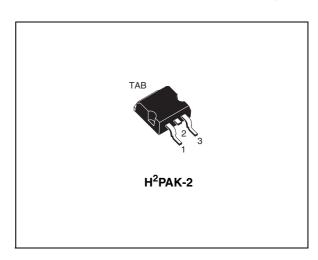


Figure 1. Internal schematic diagram

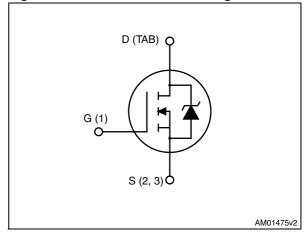


Table 1. Device summary

Order code	Marking	Package	Packaging
STH360N4F6-2	360N4F6	H <sup>2</sup> PAK-2	Tape and reel

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STH260N6F6-2 Electrical ratings

# 1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
$V_{DS}$	Drain-source voltage	40	V
V <sub>GS</sub>	Gate-source voltage	± 20	V
I <sub>D</sub> <sup>(1)</sup>	Drain current (continuous) at T <sub>C</sub> = 25 °C	180	Α
I <sub>D</sub> <sup>(1)</sup>	Drain current (continuous) at T <sub>C</sub> = 100 °C	180	Α
I <sub>DM</sub> <sup>(1)</sup>	Drain current (pulsed)	720	Α
P <sub>TOT</sub>	Total dissipation at T <sub>C</sub> = 25 °C	300	W
	Derating factor	2	W/°C
T <sub>stg</sub>	Storage temperature - 55 to 175		°C
T <sub>j</sub>	Operating junction temperature	- 55 10 175	

<sup>1.</sup> Current limited by package

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R <sub>thj-case</sub>	Thermal resistance junction-case max	0.5	°C/W
R <sub>thj-pcb</sub> <sup>(1)</sup>	Thermal resistance junction-pcb max	35	°C/W

<sup>1.</sup> When mounted on FR-4 board of 1 inch², 2 oz Cu

Electrical characteristics STH260N6F6-2

## 2 Electrical characteristics

 $(T_{CASE} = 25 \, ^{\circ}C \text{ unless otherwise specified})$ 

Table 4. On/off states

Symbol	Parameter Test conditions		Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage (V <sub>GS</sub> = 0)	I <sub>D</sub> = 250 μA	40			V
1	Zero gate voltage	V <sub>DS</sub> = 40 V			1	μΑ
I <sub>DSS</sub>	Drain current (V <sub>GS</sub> = 0)	$V_{DS} = 40 \text{ V}, T_{C} = 125 ^{\circ}\text{C}$			100	μΑ
I <sub>GSS</sub>	Gate-body leakage current (V <sub>DS</sub> = 0)	V <sub>GS</sub> = ± 20 V			± 100	nA
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$	3		4.5	٧
R <sub>DS(on)</sub>	Static drain-source on-resistance	$V_{GS} = 10 \text{ V}, I_D = 60 \text{ A}$		TBD	1.25	mΩ

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C <sub>iss</sub>	Input capacitance			17930		pF
C <sub>oss</sub>	Output capacitance	$V_{DS} = 25 \text{ V, f} = 1 \text{ MHz,}$ $V_{GS} = 0$	-	1560	-	pF
C <sub>rss</sub>	Reverse transfer capacitance	$V_{GS} = 0$		1170		pF
$Q_g$	Total gate charge			340		nC
$Q_{gs}$	Gate-source charge	$V_{DD} = 20 \text{ V}, I_{D} = 120 \text{ A},$ $V_{GS} = 10 \text{ V}$	-	TBD	-	nC
$Q_{gd}$	Gate-drain charge	VGS - 10 V		TBD		nC

Table 6. Switching times

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Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub> t <sub>r</sub>	Turn-on delay time Rise time	V <sub>DD</sub> = 20 V, I <sub>D</sub> = 60 A	-	TBD	-	ns
t <sub>d(off)</sub>	Turn-off-delay time Fall time	$R_{G} = 4.7 \Omega V_{GS} = 10 V$	-	TBD	-	ns

Table 7. Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I <sub>SD</sub> <sup>(1)</sup>	Source-drain current				180	Α
I <sub>SDM</sub> <sup>(1)</sup>	Source-drain current (pulsed)				720	Α
V <sub>SD</sub> <sup>(2)</sup>	Forward on voltage	I <sub>SD</sub> = 180 A, V <sub>GS</sub> = 0			1.1	٧
t <sub>rr</sub> Q <sub>rr</sub>	Reverse recovery time Reverse recovery charge	$I_{SD} = 120 \text{ A}, V_{DD} = 32 \text{ V}$ di/dt = 100 A/ $\mu$ s,	_	TBD		ns nC
I <sub>RRM</sub>	Reverse recovery current	$T_j = 150 ^{\circ}\text{C}$		100		A

<sup>1.</sup> Current limited by package

<sup>2.</sup> Pulsed: pulse duration = 300  $\mu$ s, duty cycle 1.5%

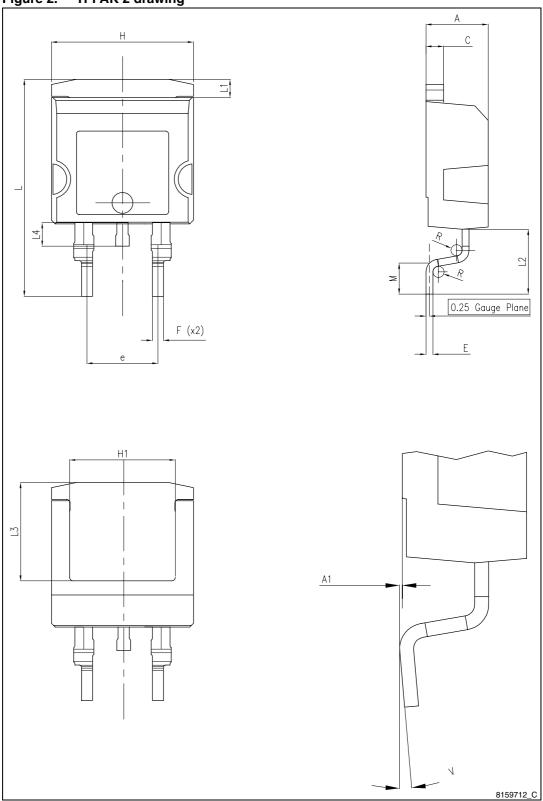
# 3 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

Table 8. H<sup>2</sup>PAK 2 mechanical data

D:		mm	
Dim.	Min.	Тур.	Max.
А	4.30		4.80
A1	0.03		0.20
С	1.17		1.37
е	4.98		5.18
Е	0.50	1	0.90
F	0.78		0.85
Н	10.00		10.40
H1	7.40		7.80
L	15.30	-	15.80
L1	1.27		1.40
L2	4.93		5.23
L3	6.85	1	7.25
L4	1.5	1	1.7
М	2.6		2.9
R	0.20	1	0.60
V	0°		8°

Figure 2. H<sup>2</sup>PAK 2 drawing



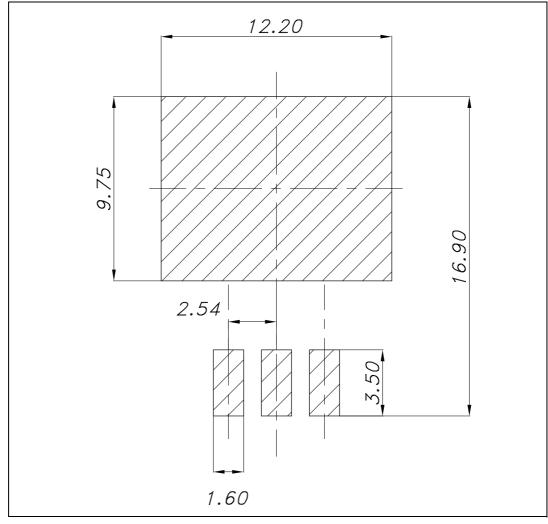


Figure 3. H<sup>2</sup>PAK 2 recommended footprint

# 4 Packaging mechanical data

Table 9. H<sup>2</sup>PAK 2 tape and reel mechanical data

	Таре			Reel	
Dim	n	nm	Dim	n	ım
Dim.	Min.	Max.	Dim.	Min.	Max.
A0	10.5	10.7	Α		330
В0	15.7	15.9	В	1.5	
D	1.5	1.6	С	12.8	13.2
D1	1.59	1.61	D	20.2	
Е	1.65	1.85	G	24.4	26.4
F	11.4	11.6	N	100	
K0	4.8	5.0	Т		30.4
P0	3.9	4.1			
P1	11.9	12.1		Base qty	1000
P2	1.9	2.1		Bulk qty	1000
R	50				
Т	0.25	0.35			
W	23.7	24.3			

Figure 4. Tape

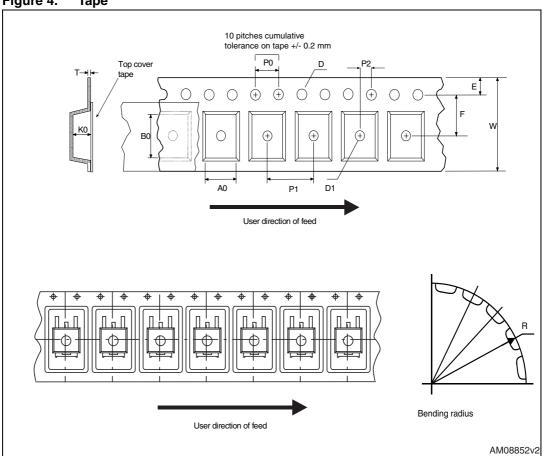
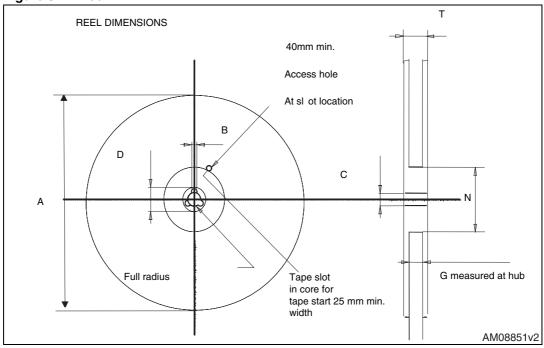


Figure 5. Reel



STH260N6F6-2 Revision history

# 5 Revision history

Table 10. Document revision history

Date	Revision	Changes
08-Aug-2012	1	First release.

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